### imall

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#### 3.2x2.4mm SMD CHIP LED LAMP

Part Number: APBD3224ESGC-F01

High Efficiency Red Super Bright Green

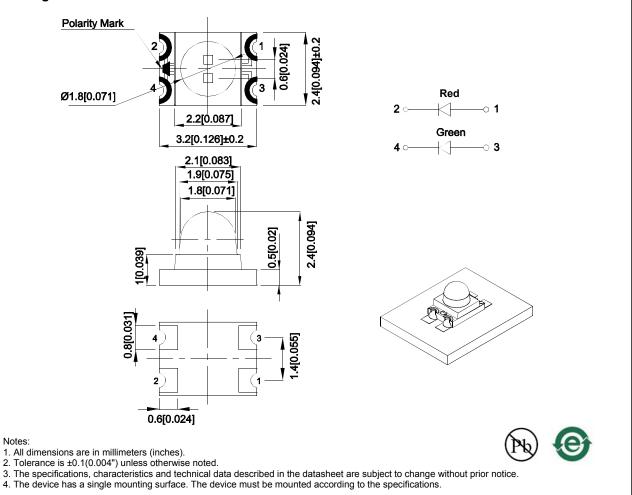
#### Features

- 3.2x2.4mm SMD LED, 2.4mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Package : 1500pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### Descriptions

- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.
- The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

#### **Package Dimensions**



SPEC NO: DSAF1337 APPROVED: Wynec REV NO: V.9A CHECKED: Allen Liu DATE: NOV/10/2015 DRAWN: L.Q.Xie PAGE: 1 OF 6 ERP: 1203000867

#### **Selection Guide** Viewing lv (mcd) [2] @ 20mA Angle [1] Part No. **Emitting Color (Material)** Lens Type 201/2 Min. Тур. 30 70 High Efficiency Red (GaAsP/GaP) \*12 \*40 APBD3224ESGC-F01 Water Clear 20° 20 55 Super Bright Green (GaP) \*20 \*55

Notes:

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous Flux: +/-15%.
\* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red Super Bright Green	627 565		nm	I⊧=20mA
λD [1]	Dominant Wavelength	High Efficiency Red Super Bright Green	617 568		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red Super Bright Green	45 30		nm	I⊧=20mA
С	Capacitance	High Efficiency Red Super Bright Green	15 15		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	High Efficiency Red Super Bright Green	2 2.2	2.5 2.5	V	I⊧=20mA
lr	Reverse Current	High Efficiency Red Super Bright Green		10 10	uA	VR = 5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

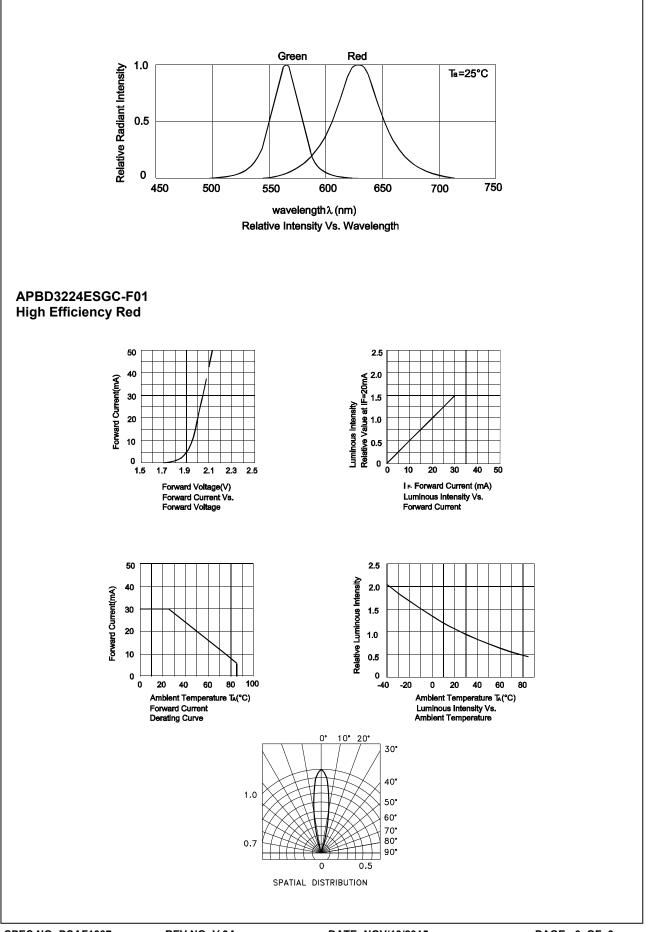
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

#### Absolute Maximum Ratings at TA=25°C

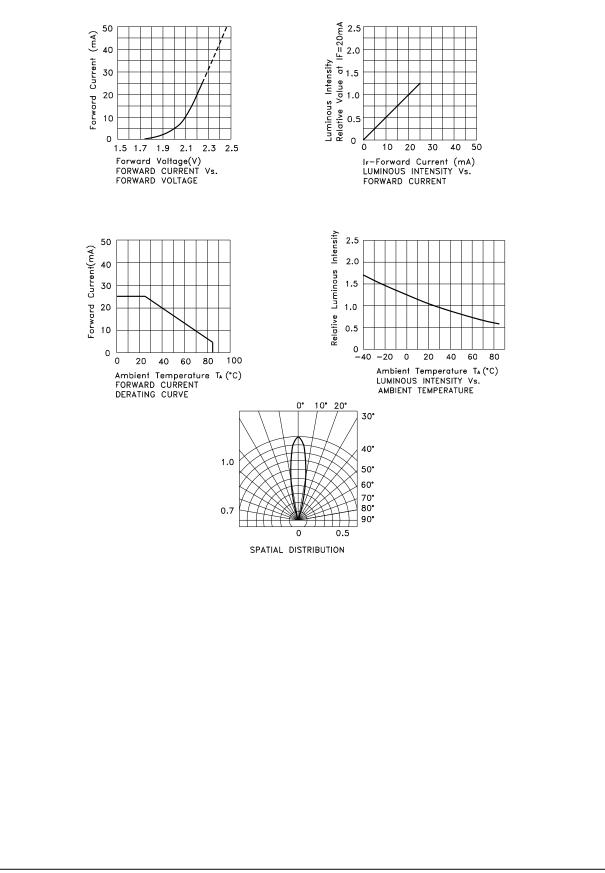
Parameter	High Efficiency Red Super Bright Green		Units		
Power dissipation	75	62.5	mW		
DC Forward Current	30	25	mA		
Peak Forward Current [1]	160	140	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



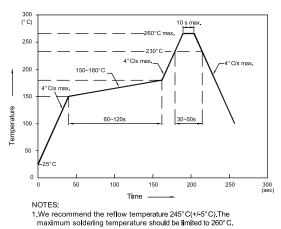
### Super Bright Green



#### APBD3224ESGC-F01

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

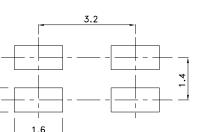


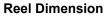


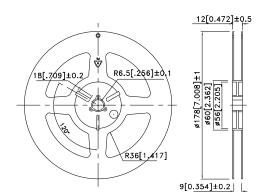
2 Don't cause stress to the epoxy resin while it is exposed

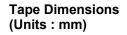
to high temperature. 3.Number of reflow process shall be 2 times or less.



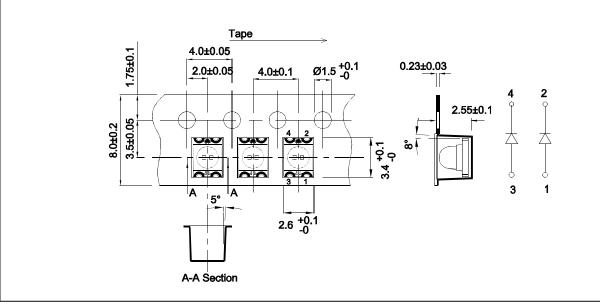








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